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PATENT 95658CON

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Art Unit: 2814

Title: METHOD FOR FORMING A

SEMICONDUCTOR CONNECTION

In re application of: Gonzalez et al.

WITH A TOP SURFACE HAVING AN ENLARGED

RECESS

Filed: December 4, 1997

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Serial Number: 08/958,088

: Group: 2800

## REQUEST FOR CORRECTED FILING RECEIPT

July 6, 1998

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U.S. Patent and Trademark Office Application Processing Division Customer Correction Branch Washington, DC 20231

Jul 2 7 1998

**GROUP 2100** 

Sir:

A filing receipt for the above-referenced application has been received and should be corrected to indicate that the application claims priority from U.S. Patent application serial number 08/595,834, filed February 2, 1996.

Enclosed is a copy of the filing receipt marked with the correction. A corrected Filing Receipt is respectfully requested.

Respectfully submitted,

Darren E. Wolf

Registration N $\phi$ l. 36,310

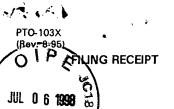
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Date of Deposit July 6, 1998

I hereby certify that this paper is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and is addressed to the U.S. Patent and Trademark Office, Application Processing Division, Customer Correction Branch, Washington, DC 20231

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Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Application Processing Division's Customer Correction Branch within 10 days of receipt. Please provide a copy of the Filing Receipt with the changes noted thereon.

Applicant(s)

FERNANDO GONZALEZ, BOISE, ID; GUY BLALOCK, BOISE, ID; KIRK PRALL, BOISE, ID.

CONTINUING DATA AS CLAYMED BY APPLICANT-THIS APPLN IS A CON OF 08/595,834, 2/2/96

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METHOD FOR FORMING A SEMICONDUCTOR CONNECTION WITH A TOP SURFACE HAVING AN ENLARGED RECESS

PRELIMINARY CLASS: 438

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